## INTEGRATED CIRCUITS



Product specification

2000 Jul 18



FEATURES	
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FEATURES	PIN CONFIGURATION	
• 5 $\Omega$ typical r <sub>on</sub>		_
Pull-up on B port		56 1A
<ul> <li>Undershoot protection on A port only: -1.5 V</li> </ul>	2B1 2	55 1B2
Near zero propagation delay	2A 3 3B1 4	54 2B2 53 3A
Controlled enable rate	3B1 4 4B1 5	53 3A 52 3B2
• V <sub>CC</sub> operating range: +4.5 V to +5.5 V	4A 6	51 4B2
<ul> <li>&gt; 100 MHz bandwidth (or clock rate) at 20 pF load capacitance</li> </ul>	5B1 7	50 5A
56-pin TSSOP package	6B1 8	49 5B2
<ul> <li>Bias voltage pre-charges the B output when the channel is</li> </ul>	6A 9	48 6B2
disabled	7B1 10	47 7A
<ul> <li>Latch-up protection exceeds 100 mA per JESD78</li> </ul>	8B1 11	46 7B2
<ul> <li>ESD protection exceeds 2000 V HBM per JESD22-A114,</li> </ul>	8A 12	45 8B2
200 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101	GND 13	44 GND
	V <sub>CC</sub> 14 9B1 15	43 V <sub>CC</sub> 42 9A
APPLICATION	10B1 16	42 97 41 9B2
Provides PCI hot-plugging	10A 17	40 10B2
	11B1 18	39 11A
	12B1 19	38 11B2
DESCRIPTION The CBT6832 is a 16-bit 1-of-2 multiplexer/demultiplexer with	12A 20	37 12B2
precharged outputs and charge pump undershoot protection for live	13B1 21	36 13A
insertion. Advantages of the CBT6832 include a propagation delay	14B1 22	35 13B2
of 250 ps, resulting from 5 $\Omega$ channel resistance, and low I/O capacitance. A port demultiplexes to either 1B and 2B, or to both.	14A 23	34 14B2
The switch is bi-directional.	15B1 24	33 15A
	16B1 25	32 15B2
	16A 26	31 16B2
	V <sub>BIAS1</sub> 27	30 V <sub>BIAS2</sub>
	SEL1 28	29 SEL2

## QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T <sub>amb</sub> = 25°C; GND = 0 V	TYPICAL	UNIT
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An to Bn or Bn to An	C <sub>L</sub> = 50 pF; V <sub>CC</sub> = 5 V	0.25	ns
C <sub>IN</sub>	Input capacitance	$V_{I} = 0 V \text{ or } V_{CC}$	4.5	pF
С <sub>ОUТ В</sub>	B capacitance	Outputs disabled; $V_0 = 0 V$	8	pF
C <sub>OUT A</sub>	A capacitance	Outputs disabled; $V_0 = 0 V$	13	pF
C <sub>ON 1</sub>	One channel on capacitance	One B enabled; $V_0 = 0 V$	21	pF
C <sub>ON 2</sub>	Both channels on capacitance	Both B channels enabled; $V_0 = 0 V$	34	pF

#### **ORDERING INFORMATION**

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DWG NUMBER
56-Pin Plastic TSSOP Type II	0°C to +70°C	CBT6832C DGG	SOT364-1

SW00478

## CBT6832C

#### **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	NAME AND FUNCTION
3, 6, 9, 12, 17, 20, 23, 26, 33, 36, 39, 42, 47, 50, 53, 56	1A1–16A1	Inputs
1, 2, 4, 5, 7, 8, 10, 11, 15, 16, 18, 19, 21, 22, 24, 25	1B1–16B1	Outputs
31, 32, 34, 35, 37, 38, 40, 41, 45, 46, 48, 49, 51, 52, 54, 55	1B2–16B2	Outputs
27, 30	V <sub>BIAS1</sub> , V <sub>BIAS2</sub>	Precharge bias voltage inputs
28, 29	SEL1, SEL2 Select-control inputs	
13, 44	GND	Ground (0 V)
14, 43	V <sub>CC</sub>	Positive supply voltage

#### **FUNCTION TABLE**

SEL1	SEL2	FUNCTION
L	Н	nA to nB1
Н	L	nA to nB2
L	L	nA to nB1 and nB2
Н	Н	nB1, nB2 = V <sub>BIAS</sub>

### LOGIC DIAGRAM



#### ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +7.0	V
I <sub>IK</sub>	DC input diode current	V <sub>1</sub> < 0	-50	mA
VI	DC input voltage <sup>3</sup>		-0.5 to +7.0	V
V <sub>OUT</sub>	DC output voltage <sup>3</sup>	output in Off or High state	-0.5 to +7.0	V
I <sub>OUT</sub>	DC output current	output in Low state	120	mA
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C
$\Theta_{JA}$	Power dissipation		95	°C/W

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C. 3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	YMBOL PARAMETER	LIM	UNIT	
STWIDOL	FARAIVIETER	MIN	MAX	UNIT
V <sub>CC</sub>	DC supply voltage	4.5	5.5	V
V <sub>IH</sub>	H High-level input voltage			V
VIL	V <sub>IL</sub> Low-level Input voltage		0.8	V
T <sub>amb</sub>	Operating free-air temperature range	0	+70	°C

## CBT6832C

## DC ELECTRICAL CHARACTERISTICS

Over operating temperature range T<sub>amb</sub> = 0°C to +70°C; V<sub>CC</sub> = 5 V ±10%; V<sub>BIAS</sub> = 1.3 V to V<sub>CC</sub>, unless otherwise specified.

CVMDO!	DADAMETER	TEST CONDITIONS		LIMITS		
SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP <sup>1</sup>	MAX	UNIT
VIH	Input HIGH voltage	Guaranteed logic HIGH level	2.0			V
VIL	Input LOW voltage	Guaranteed logic LOW level	-0.5		0.8	V
I <sub>IH</sub>	Input HIGH current	$V_{CC} = 5.5 \text{ V}, V_{IN} = V_{CC}$			±5	μΑ
۱ <sub>IL</sub>	Input LOW current	$V_{CC} = 5.5 \text{ V}, V_{IN} = \text{GND}$			±5	μΑ
I <sub>OZH</sub>	High impedance output current				±1	μA
I <sub>OZL</sub>	Low impedance output current	$            B = 0 V \text{ or } V_{CC} \text{ MAX}, \\             V_{BIAS1} = V_{BIAS2} = V_{CC} \text{ MAX} $	-0.2		-2	mA
V <sub>IK</sub>	Input clamp voltage	$V_{CC} = 4.5 \text{ V}; \text{ I}_{\text{I}} = -18 \text{ mA}$		-0.7	-1.8	V
	Particle or matchese 2	V <sub>CC</sub> = 4.5 V; V <sub>I</sub> = 0 V; I <sub>I</sub> = 48 mA		5	8	Ω
r <sub>on</sub>	Switch on resistance <sup>2</sup>	$V_{CC} = 4.5 \text{ V}; \text{ V}_{I} = 2.4 \text{ V}; \text{ I}_{I} = -15 \text{ mA}$		10	15	Ω
Capacitanc	:e <sup>3</sup> (T <sub>amb</sub> = +25°C; f = 1 MHz)	-		-	-	-
CIN	Input capacitance	$V_{I} = 0 V$		4.5		pF
C <sub>OFF</sub> B	B capacitance, switch off	V <sub>I</sub> = 0 V		8		pF
C <sub>OFF</sub> A	A capacitance, switch off	V <sub>I</sub> = 0 V		13		рF
C <sub>ON</sub> 1	One B channel on capacitance	V <sub>I</sub> = 0 V		21		pF
C <sub>ON</sub> 2	Both B channels on capacitance	V <sub>I</sub> = 0 V		34		рF
Power sup	ply	-		-	•	-
I <sub>CC</sub>	Quiescent supply current enable	$V_{CC} = 5.5 \text{ V}; \text{ V}_{I} = V_{CC} \text{ or GND}$			200	μΑ
$\Delta I_{CC}$	Additional supply current per input pin <sup>5</sup>	$V_{CC}$ = 5.5 V, one input at 3.4 V, other inputs at V <sub>CC</sub> or GND			2.5	mA

NOTES:

All typical values are at V<sub>CC</sub> = 5 V, T<sub>amb</sub> = +25°C ambient and maximum loading.
 Measured by the voltage drop between the A and the B terminals at the indicated current through the switch.

On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

These parameters are determined by device characterization, but is not production tested. 3.

4. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.

5. Per TTL driven input ( $V_1$  = 3.4 V, control inputs only); A and B pins do not contribute to I<sub>CC</sub>. 6. This current applies to the control inputs only and represent the current required to switch internal capacitance at the specified frequency. The A and B inputs generate no significant AC or DC currents as they transition. this parameter is not tested, but is guaranteed by design.

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### AC CHARACTERISTICS

 $V_{CC}$  = 5.0 V ±0.5 V; GND = 0 V;  $C_L$  = 50 pF,  $R_L$  = 500  $\Omega$ 

SYMBOL	PARAMETER	TEST CONDITIONS		LIMITS		UNIT
STMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay <sup>1</sup> A to B			0.25		ns
t <sub>PZH</sub> t <sub>PZL</sub>	Bus enable time SEL to A, B		1 1		7.0 6.0	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	Bus disable time SEL to A, B		1 1		7.5 7.0	ns

NOTES:

1. This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance).

#### **AC WAVEFORMS**

 $V_{M}$  = 1.5 V,  $V_{IN}$  = GND to 3.0 V



Waveform 1. Input (An) to Output (Bn) Propagation Delays



Waveform 2. 3-State Output Enable and Disable Times

#### **TEST CIRCUIT AND WAVEFORMS**



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## CBT6832C

NOTES

## CBT6832C

#### Data sheet status

Data sheet status	Product status	Definition <sup>[1]</sup>
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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